

# 74ABT245

Octal transceiver with direction pin; 3-state

Rev. 5 — 9 July 2021

Product data sheet

## 1. General description

The 74ABT245 is an 8-bit transceiver with 3-state outputs. The device features an output enable ( $\overline{OE}$ ) and send/receive (DIR) for direction control. A HIGH on  $\overline{OE}$  causes the outputs to assume a high-impedance OFF-state. This device is fully specified for partial power down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing the potentially damaging backflow current through the device when it is powered down.

## 2. Features and benefits

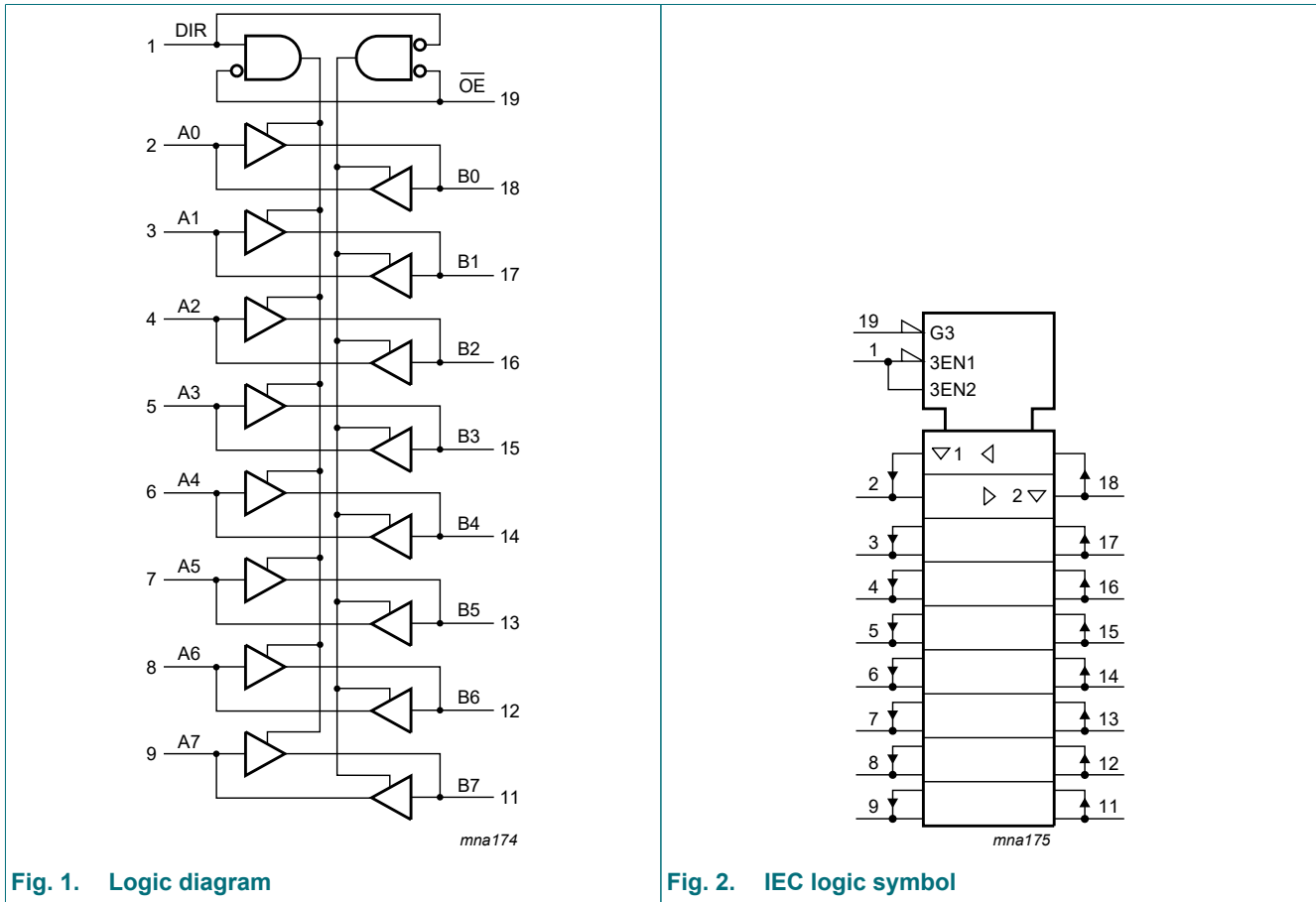
- Octal bidirectional bus interface
- 3-State buffers
- Supply voltage range from 4.5 to 5.5 V
- BiCMOS high speed and output drive
- Direct interface with TTL levels
- Output capability: +64 mA/-32 mA
- Power-up 3-State
- Live insertion/extraction permitted
- Inputs are disabled during 3-state mode
- $I_{OFF}$  circuitry provides partial Power-down mode operation
- Latch-up protection exceeds 500 mA per JESD78 class II level A
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- Specified from -40 °C to +85 °C

## 3. Ordering information

Table 1. Ordering information

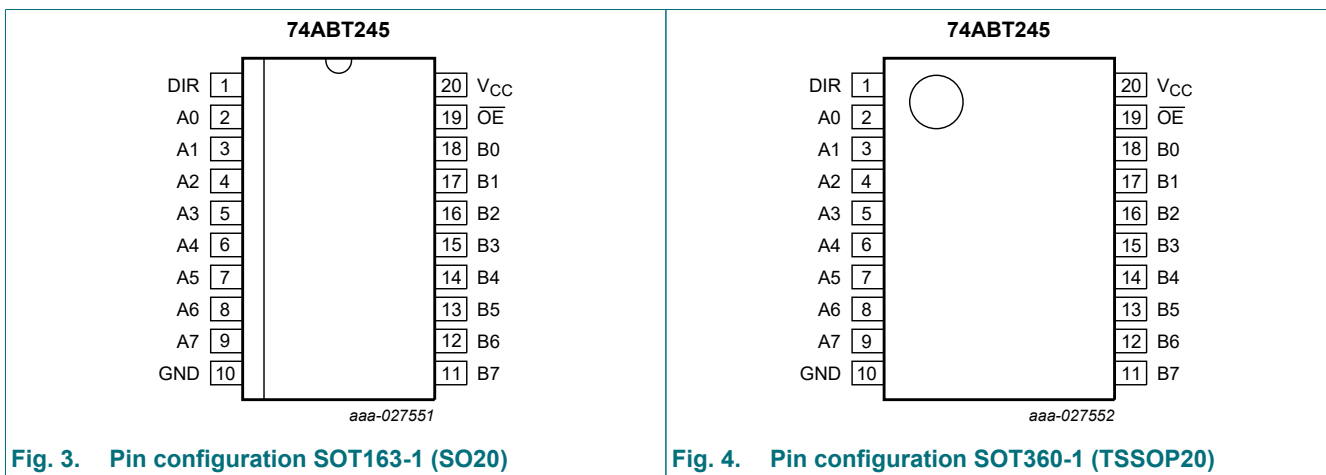
| Type number | Package           |         |   | Version  |
|-------------|-------------------|---------|---|----------|
|             | Temperature range | Name    | Description   |          |
| 74ABT245D   | -40 °C to +85 °C  | SO20    | plastic small outline package; 20 leads;<br>body width 7.5 mm             | SOT163-1 |
| 74ABT245PW  | -40 °C to +85 °C  | TSSOP20 | plastic thin shrink small outline package; 20 leads;<br>body width 4.4 mm | SOT360-1 |

### 4. Functional diagram



### 5. Pinning information

#### 5.1. Pinning



## 5.2. Pin description

Table 2. Pin description

| Symbol                         | Pin                            | Description                      |
|--------------------------------|--------------------------------|----------------------------------|
| DIR                            | 1                              | direction control input          |
| A0, A1, A2, A3, A4, A5, A6, A7 | 2, 3, 4, 5, 6, 7, 8, 9         | data input/output                |
| GND                            | 10                             | ground (0 V)                     |
| B0, B1, B2, B3, B4, B5, B6, B7 | 18, 17, 16, 15, 14, 13, 12, 11 | data input/output                |
| $\overline{OE}$                | 19                             | output enable input (active LOW) |
| V <sub>CC</sub>                | 20                             | supply voltage                   |

## 6. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state

| Input           |     | Input/output   |                |
|-----------------|-----|----------------|----------------|
| $\overline{OE}$ | DIR | An             | Bn             |
| L               | L   | output An = Bn | input          |
| L               | H   | input          | output Bn = An |
| H               | X   | Z              | Z              |

## 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol           | Parameter               | Conditions                            | Min  | Max  | Unit |
|------------------|-------------------------|---------------------------------------|------|------|------|
| V <sub>CC</sub>  | supply voltage          |                                       | -0.5 | +7.0 | V    |
| V <sub>I</sub>   | input voltage           | [1]                                   | -1.2 | +7.0 | V    |
| V <sub>O</sub>   | output voltage          | output in OFF-state or HIGH-state [1] | -0.5 | +5.5 | V    |
| I <sub>IK</sub>  | input clamping current  | V <sub>I</sub> < 0 V                  | -18  | -    | mA   |
| I <sub>OK</sub>  | output clamping current | V <sub>O</sub> < 0 V                  | -50  | -    | mA   |
| I <sub>O</sub>   | output current          | output in LOW-state                   | -    | 128  | mA   |
| T <sub>j</sub>   | junction temperature    | [2]                                   | -    | 150  | °C   |
| T <sub>stg</sub> | storage temperature     |                                       | -65  | +150 | °C   |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150 °C.

## 8. Recommended operating conditions

**Table 5. Operating conditions**

Voltages are referenced to GND (ground = 0 V).

| Symbol              | Parameter                           | Conditions  | Min | Typ | Max      | Unit |
|---------------------|-------------------------------------|-------------|-----|-----|----------|------|
| $V_{CC}$            | supply voltage                      |             | 4.5 | -   | 5.5      | V    |
| $V_I$               | input voltage                       |             | 0   | -   | $V_{CC}$ | V    |
| $I_{OH}$            | HIGH-level output current           |             | -   | -   | -32      | mA   |
| $I_{OL}$            | LOW-level output current            |             | -   | -   | 64       | mA   |
| $\Delta t/\Delta V$ | input transition rise and fall rate |             | 0   | -   | 5        | ns/V |
| $T_{amb}$           | ambient temperature                 | in free air | -40 | -   | +85      | °C   |

## 9. Static characteristics

**Table 6. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol         | Parameter                                 | Conditions   | $T_{amb} = 25\text{ °C}$ |            |           | $T_{amb} = -45\text{ °C to }+85\text{ °C}$ |           | Unit          |
|----------------|---|--|--------------------------|------------|-----------|--|-----------|---------------|
|                |   |  | Min                      | Typ        | Max       | Min  | Max       |               |
| $V_{IK}$       | input clamping voltage                    | $V_{CC} = 4.5\text{ V}; I_{IK} = -18\text{ mA}$  | -1.2                     | -0.9       | -         | -1.2                                       | -         | V             |
| $V_{IH}$       | HIGH-level input voltage                  |  | 2.0                      | -          | -         | 2.0  | -         | V             |
| $V_{IL}$       | LOW-level input voltage                   |  | -                        | -          | 0.8       | -  | 0.8       | V             |
| $V_{OH}$       | HIGH-level output voltage                 | $V_{CC} = 4.5\text{ V}; V_I = V_{IL}\text{ or }V_{IH}$   |                          |            |           |  |           |               |
|                |   | $I_{OH} = -3\text{ mA}$  | 2.5                      | 2.9        | -         | 2.5  | -         | V             |
|                |   | $I_{OH} = -32\text{ mA}$   | 2.0                      | 2.4        | -         | 2.0  | -         | V             |
|                |   | $V_{CC} = 5.0\text{ V}; V_I = V_{IL}\text{ or }V_{IH}$   |                          |            |           |  |           |               |
|                |   | $I_{OH} = -3\text{ mA}$  | 3.0                      | 3.4        | -         | 3.0  | -         | V             |
| $V_{OL}$       | LOW-level output voltage                  | $V_{CC} = 4.5\text{ V}; V_I = V_{IL}\text{ or }V_{IH}; I_{OL} = 64\text{ mA}$                                  | -                        | 0.42       | 0.55      | -  | 0.55      | V             |
| $I_I$          | input leakage current                     | Control pins;<br>$V_{CC} = 5.5\text{ V}; V_I = \text{GND or }5.5\text{ V}$                                     | -                        | $\pm 0.01$ | $\pm 1.0$ | -  | $\pm 1.0$ | $\mu\text{A}$ |
|                |   | Data pins;<br>$V_{CC} = 5.5\text{ V}; V_I = \text{GND or }5.5\text{ V}$  | -                        | $\pm 5$    | $\pm 100$ | -  | $\pm 100$ | $\mu\text{A}$ |
| $I_{OFF}$      | power-off leakage current                 | $V_{CC} = 0\text{ V}; V_O\text{ or }V_I \leq 4.5\text{ V}$   | -                        | $\pm 5.0$  | $\pm 100$ | -  | $\pm 100$ | $\mu\text{A}$ |
| $I_{O(pu/pd)}$ | power-up/<br>power-down<br>output current | $V_{CC} = 2.0\text{ V}; V_O = 0.5\text{ V}; V_I = \text{GND or }V_{CC}; \overline{OE} = \text{don't care}$ [1] | -                        | $\pm 5.0$  | $\pm 50$  | -  | $\pm 50$  | $\mu\text{A}$ |
| $I_{OZ}$       | OFF-state output current                  | $V_{CC} = 5.5\text{ V}; V_I = V_{IL}\text{ or }V_{IH}$   |                          |            |           |  |           |               |
|                |   | output HIGH-state at $V_O = 2.7\text{ V}$  | -                        | 5.0        | 50        | -  | 50        | $\mu\text{A}$ |
|                |   | output LOW-state at $V_O = 0.5\text{ V}$   | -                        | -5.0       | -50       | -  | -50       | $\mu\text{A}$ |
| $I_{CEX}$      | output high leakage current               | $V_{CC} = 5.5\text{ V}; V_O = 5.5\text{ V}; V_I = \text{GND or }V_{CC}$  | -                        | 5.0        | 50        | -  | 50        | $\mu\text{A}$ |
| $I_O$          | output current                            | $V_{CC} = 5.5\text{ V}; V_O = 2.5\text{ V}$ [2]  | -40                      | -100       | -180      | -40  | -180      | mA            |

| Symbol           | Parameter                 | Conditions   | T <sub>amb</sub> = 25 °C |     |     | T <sub>amb</sub> = -45 °C to +85 °C |     | Unit |
|------------------|---------------------------|--|--------------------------|-----|-----|-------------------------------------|-----|------|
|                  |                           |  | Min                      | Typ | Max | Min                                 | Max |      |
| I <sub>CC</sub>  | supply current            | V <sub>CC</sub> = 5.5 V; V <sub>I</sub> = GND or V <sub>CC</sub>                           |                          |     |     |                                     |     |      |
|                  |                           | outputs HIGH-state   | -                        | 50  | 250 | -                                   | 250 | μA   |
|                  |                           | outputs LOW-state  | -                        | 24  | 30  | -                                   | 30  | mA   |
|                  |                           | outputs disabled   | -                        | 50  | 250 | -                                   | 250 | μA   |
| ΔI <sub>CC</sub> | additional supply current | per input pin; V <sub>CC</sub> = 5.5 V   |                          |     |     |                                     |     |      |
|                  |                           | outputs enabled; one input at 3.4 V and other inputs at V <sub>CC</sub> or GND [3]         | -                        | 0.5 | 1.5 | -                                   | 1.5 | mA   |
|                  |                           | outputs disabled; one data input at 3.4 V and other inputs at V <sub>CC</sub> or GND [3]   | -                        | 50  | 250 | -                                   | 250 | μA   |
|                  |                           | outputs disabled; one enable input at 3.4 V and other inputs at V <sub>CC</sub> or GND [3] | -                        | 0.5 | 1.5 | -                                   | 1.5 | mA   |
| C <sub>I</sub>   | input capacitance         | DIR; $\overline{OE}$ ; V <sub>I</sub> = 0 V or V <sub>CC</sub>                             | -                        | 4   | -   | -                                   | -   | pF   |
| C <sub>I/O</sub> | input/output capacitance  | outputs disabled; V <sub>O</sub> = 0 V or V <sub>CC</sub>                                  | -                        | 7   | -   | -                                   | -   | pF   |

[1] This parameter is valid for any V<sub>CC</sub> between 0 V and 2.1 V, with a transition time of up to 10 ms.

From V<sub>CC</sub> = 2.1 V to V<sub>CC</sub> = 5 V ± 10 % a transition time of up to 100 μs is permitted.

[2] Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

[3] This is the increase in supply current for each input at 3.4 V.

## 10. Dynamic characteristics

**Table 7. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 7.

| Symbol           | Parameter                           | Conditions  | T <sub>amb</sub> = 25 °C; V <sub>CC</sub> = 5.0 V |     |     | T <sub>amb</sub> = -40 °C to 85 °C;<br>V <sub>CC</sub> = 5.0 V ± 0.5 V |     | Unit |
|------------------|-------------------------------------|---|---|-----|-----|--|-----|------|
|                  |                                     |   | Min   | Typ | Max | Min  | Max |      |
| t <sub>PLH</sub> | LOW to HIGH propagation delay       | A <sub>n</sub> to B <sub>n</sub> or B <sub>n</sub> to A <sub>n</sub> ; see Fig. 5 | 1.0   | 2.2 | 4.1 | 1.0  | 4.6 | ns   |
| t <sub>PHL</sub> | HIGH to LOW propagation delay       | A <sub>n</sub> to B <sub>n</sub> or B <sub>n</sub> to A <sub>n</sub> ; see Fig. 5 | 1.0   | 2.9 | 4.2 | 1.0  | 4.6 | ns   |
| t <sub>PZH</sub> | OFF-state to HIGH propagation delay | $\overline{OE}$ to A <sub>n</sub> or B <sub>n</sub> ; see Fig. 6                  | 1.3   | 3.0 | 4.8 | 1.3  | 5.3 | ns   |
| t <sub>PZL</sub> | OFF-state to LOW propagation delay  | $\overline{OE}$ to A <sub>n</sub> or B <sub>n</sub> ; see Fig. 6                  | 2.3   | 4.0 | 5.8 | 2.3  | 6.3 | ns   |
| t <sub>PHZ</sub> | HIGH to OFF-state propagation delay | $\overline{OE}$ to A <sub>n</sub> or B <sub>n</sub> ; see Fig. 6                  | 1.0   | 4.7 | 6.2 | 1.0  | 7.2 | ns   |
| t <sub>PLZ</sub> | LOW to OFF-state propagation delay  | $\overline{OE}$ to A <sub>n</sub> or B <sub>n</sub> ; see Fig. 6                  | 1.0   | 4.1 | 5.8 | 1.0  | 6.3 | ns   |

10.1. Waveforms and test circuit

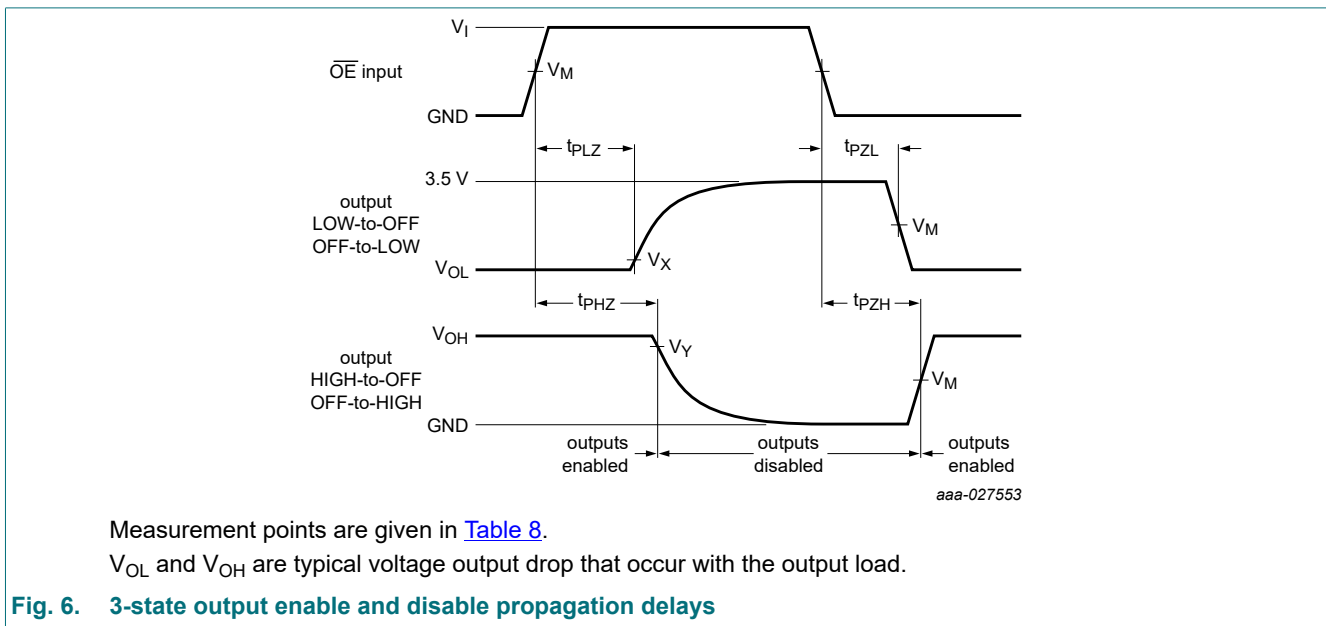
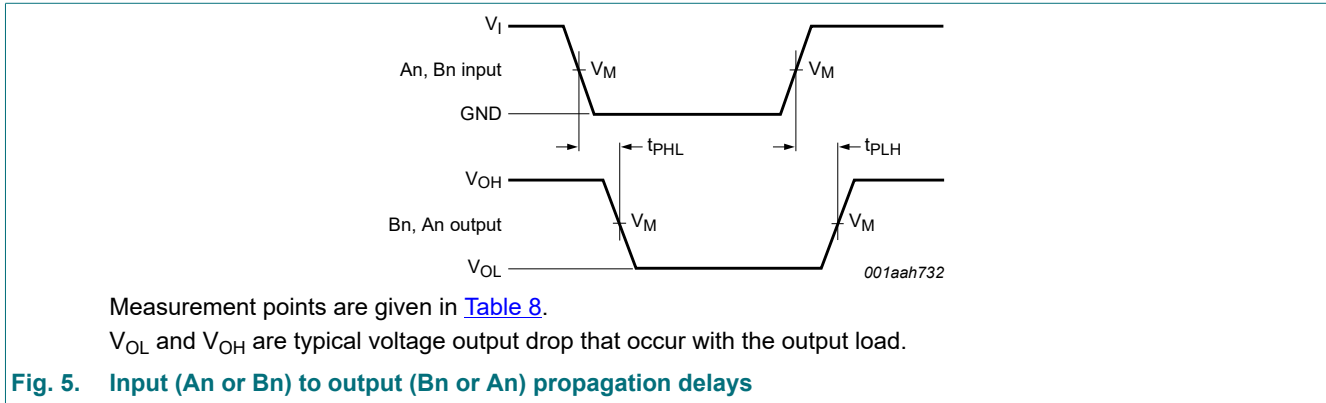
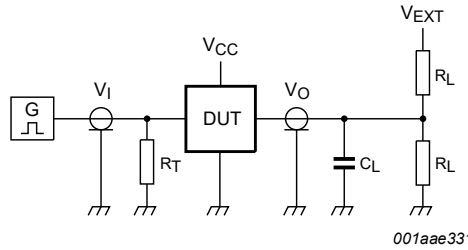
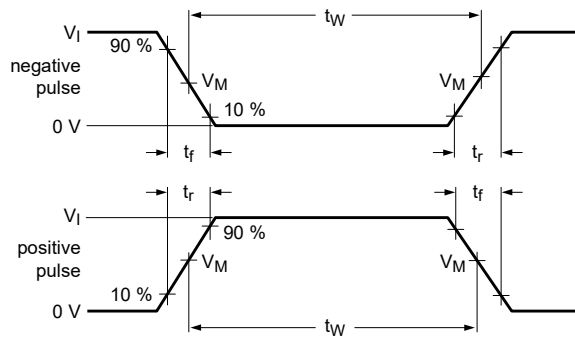


Table 8. Measurement points

| Input | Output |                  |                  |
|-------|--------|------------------|------------------|
| $V_M$ | $V_M$  | $V_X$            | $V_Y$            |
| 1.5 V | 1.5 V  | $V_{OL} + 0.3 V$ | $V_{OH} - 0.3 V$ |



001aee331

Test data is given in [Table 9](#).

Definitions test circuit:

$R_L$  = Load resistance.

$C_L$  = Load capacitance including jig and probe capacitance.

$R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

$V_{EXT}$  = Test voltage for switching times.

**Fig. 7. Test circuit for measuring switching times**

**Table 9. Test data**

| Input |              |        |               | Load  |              | $V_{EXT}$          |                    |                    |
|-------|--------------|--------|---------------|-------|--------------|--------------------|--------------------|--------------------|
| $V_I$ | $f_i$        | $t_W$  | $t_r, t_f$    | $C_L$ | $R_L$        | $t_{PHZ}, t_{PZH}$ | $t_{PLZ}, t_{PZL}$ | $t_{PLH}, t_{PHL}$ |
| 3.0 V | $\leq 1$ MHz | 500 ns | $\leq 2.5$ ns | 50 pF | 500 $\Omega$ | open               | 7 V                | open               |

### 11. Package outline

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1

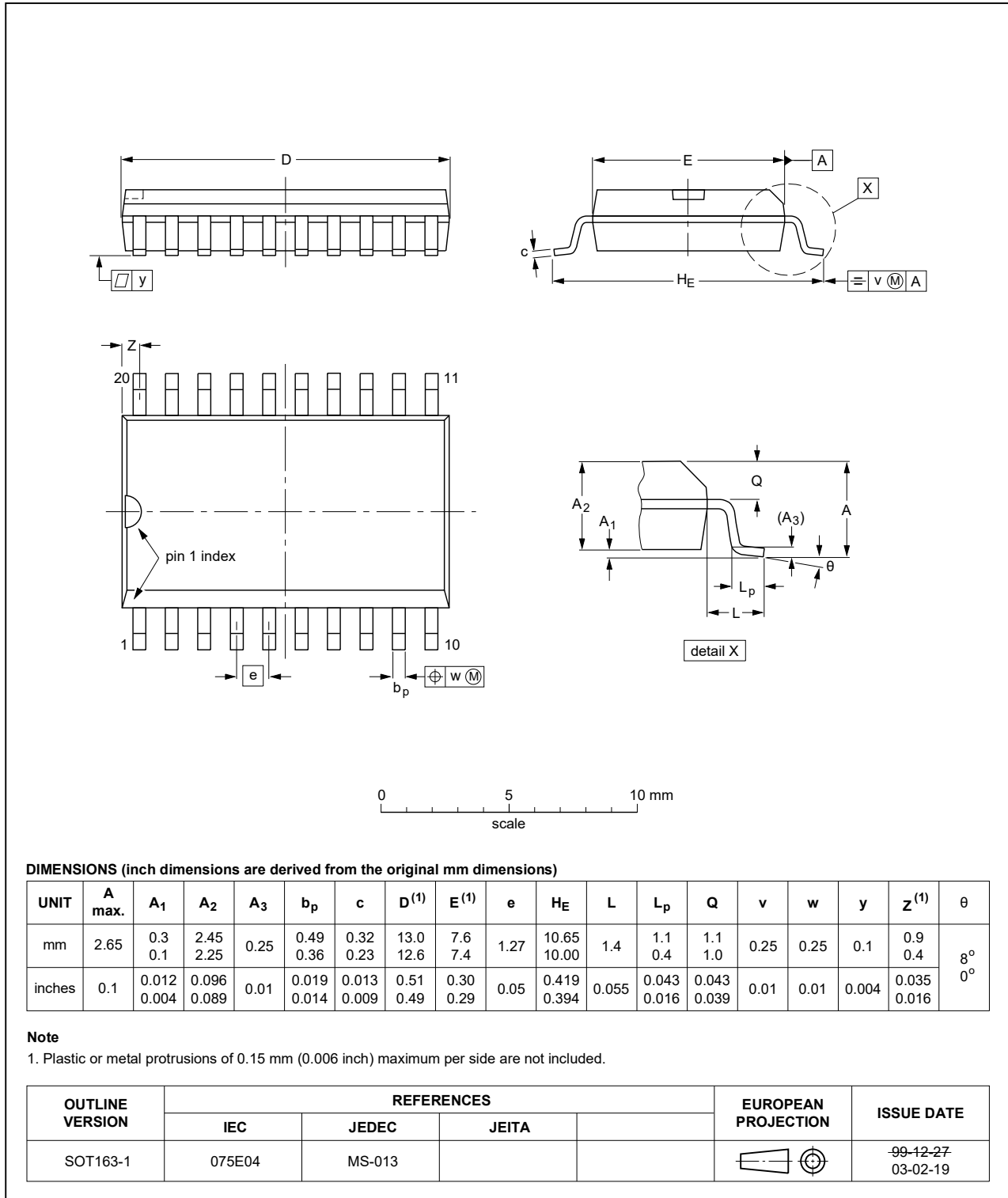


Fig. 8. Package outline SOT163-1 (SO20)



TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1

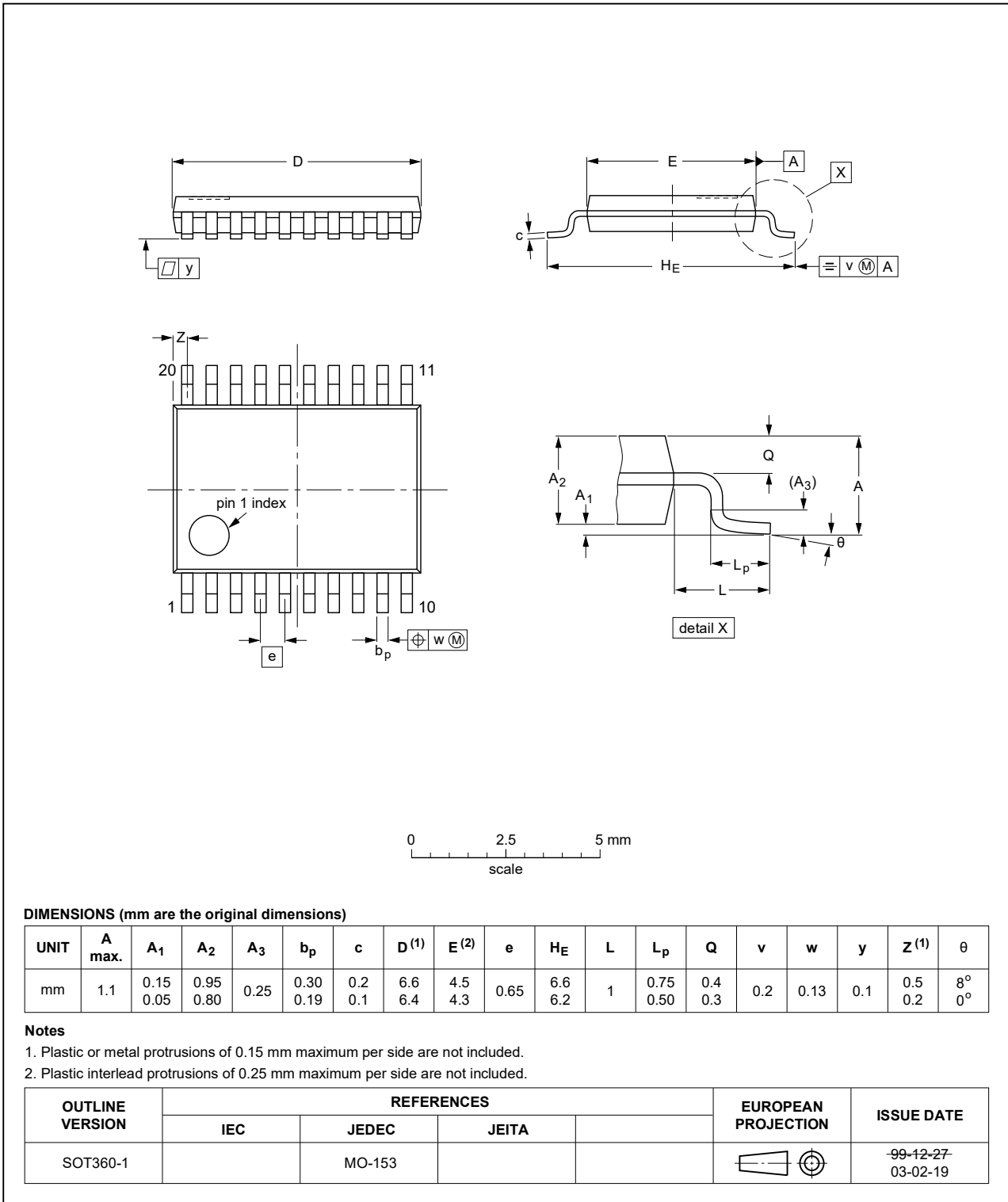


Fig. 9. Package outline SOT360-1 (TSSOP20)

## 12. Abbreviations

Table 10. Abbreviations

| Acronym | Description                                     |
|---------|---|
| BiCMOS  | Bipolar Complementary Metal Oxide Semiconductor |
| DUT     | Device Under Test                               |
| ESD     | ElectroStatic Discharge                         |
| HBM     | Human Body Model                                |
| MM      | Machine Model                                   |
| TTL     | Transistor-Transistor Logic                     |

## 13. Revision history

Table 11. Revision history

| Document ID    | Release date  | Data sheet status     | Change notice      | Supersedes   |
|----------------|---|-----------------------|--------------------|--------------|
| 74ABT245 v.5   | 20210709  | Product data sheet    | -                  | 74ABT245 v.4 |
| Modifications: | <ul style="list-style-type: none"> <li>• <a href="#">Section 1</a> and <a href="#">Section 2</a> updated.</li> <li>• Type number 74ABT245DB (SOT339-1 / SSOP20) removed.</li> </ul>   |                       |                    |              |
| 74ABT245 v.4   | 20171006  | Product data sheet    | -                  | 74ABT245 v.3 |
| Modifications: | <ul style="list-style-type: none"> <li>• The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>• Legal texts have been adapted to the new company name where appropriate.</li> </ul> |                       |                    |              |
| 74ABT245 v.3   | 20030206  | Product data sheet    | ECN 853-1447 29305 | 74ABT245 v.2 |
| Modifications: | <ul style="list-style-type: none"> <li>• Delete all references to N package. DIP20 package option discontinued.</li> </ul>  |                       |                    |              |
| 74ABT245 v.2   | 19980116  | Product specification | ECN 853-1447 18867 | 74ABT245 v.1 |
| 74ABT245 v.1   | 19960910  | Product specification | -                  | -            |

## 14. Legal information

### Data sheet status

| Document status [1][2]         | Product status [3] | Definition  |
|--------------------------------|--------------------|---|
| Objective [short] data sheet   | Development        | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification      | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production         | This document contains the product specification.                                     |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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For more information, please visit: <http://www.nexperia.com>  
For sales office addresses, please send an email to: [salesaddresses@nexperia.com](mailto:salesaddresses@nexperia.com)  
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